



# Data Sheet

Customer:	
Part No:	CL-5019RGBW1C-CC-01
Sample No:	
Description:	5mm Round Red/Green/Blue LED
Item No:	

Customer						
Check Inspection Approval Date						





### Features:

- . Choice of various viewing angles
- . Available on tape and reel.
- . Reliable and robust
- . Pb free
- .The product itself will remain within RoHS compliant version.

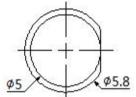
### **Technical Data Sheet**

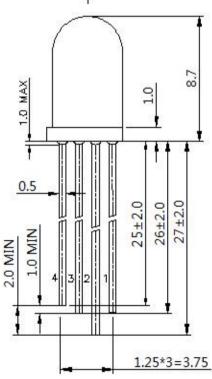
This product is generally used as indicator and luminary for electronic equipment such as household appliance, communication equipment, and dashboard.

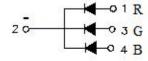
# **Applications**

- TV set
- Monitor
- **■** Telephone
- Computer

# **Package Dimensions:**









### NOTES

- 1.All dimensions are in millimeters .
- 2. Tolerance is ±0.25mm unless otherwise noted.





# **Selection Guide**

Part No.	Dice	Lens Type	Luminous intensity(mcd) @ 20mA			Viewing Angle
1 0.101.101			Min	Тур	Max	2θ1/2
CL-5019RGBW1C-CC-01	(R)AlGaInP	White Diffused	150	320		
	(G)InGaN		530	1100		40
	(B)InGaN		150	250		

#### Note:

- 1.1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- 2.the above luminous intensity measurement allowance tolerance ±15%

# Electrical / Optical Characteristics at Ta=25°C

Parameter	Device	Min.	Тур.	Max.	Units	test conditions	
	R	1.7	2.0	2.4			
Forward Voltage	G	2.7	3.0	3.6	V	IF=20mA	
	В	2.7	3.0	3.6			
Reverse Current	IR			10	uA	VR = 5V	
Dominate Wavelength	R	618		630			
	G	510		520	nm	IF=20mA	
	В	460		470			

# **Absolute Maximum Ratings at Ta=25°C**

Parameter	Symbol	Rating	Units	
	R	60		
Power Dissipation	G	90	mW	
	В	90		
DC Forward Current	IF	30	Λ	
Peak Forward Current [1]	IFP	60	mA	
Reverse Voltage	VR	5	V	
Electrostatic Discharge (HBM)	ESD	2000	V	
Operating Temperature	Topr	-40~+85		
Storage Temperature	Tstg	-40~+100	- °C	
Lead Soldering Temperature [1.6mm(.063") From Body]		260°C for 5 seconds		

### Note:

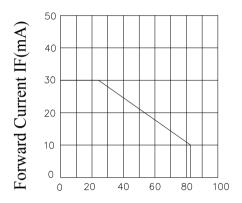
- 1. 1/10 Dut cycle,0.1ms pulse width.
- 2. Measurement Errors:Forward Voltage:±0.1V,Luminous Intensity:±10%mcd,Wavelength(x,y)±1nm/±0.01

REV NO: A/1 Page :2 of 6

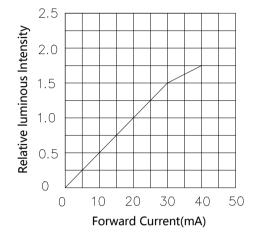


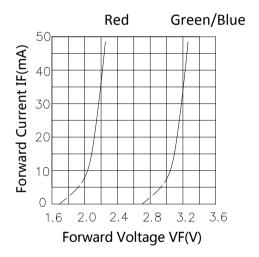
### Typical optical characteristics curves

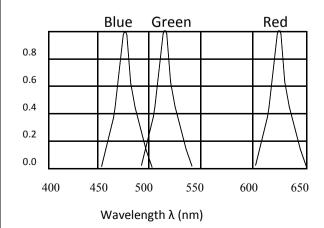
Ambient Temperature VS. Forward Current

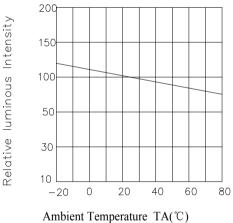


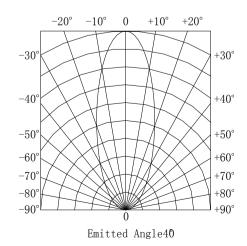
Ambient Temperature(° C)











REV NO: A/1 Page:3 of 6





**Reliability Test Item And Condition** 

Test Item	Test Condition	Ref.Standard	Time	Quantity	Ac/Re
Life Test	Ta=25℃±5℃ IF=20mA	JESD22-A108	1000H	22Pcs	0/1
Temperature cycle	100°C±5°C 30 min. ↑↓5 min -40°C±5°C 30 min.	JEITA ED-4701 100 105	100 Cycles	22Pcs	0/1
High Temperature Storage	Ta=100±5℃	JEITA ED-4701 200 201	1000H	22Pcs	0/1
Low Temperature Storage	Ta=-40±5℃	JEITA ED-4701 200 202	1000H	22Pcs	0/1
Storage at High Temperature/High Humidity	Ta:85±5℃,RH:85±5%	JEITA ED-4701 100 103	1000H	22Pcs	0/1
Soldering resistance	Tsol=260±5°C 10s	JEITA ED-4701 300 302	1 times	22Pcs	0/1
Solderability	Tsol=235±5℃ 5s	JEITA ED-4701 300 303	1 times	22Pcs	0/1

Criteria For Judging Damage

Test Items	Symbol	Test conditions	Criteria For Judgement	
			Min.	Max.
Forward Voltage	VF	IF=20mA		U.S.L*)x1.1
Reverse Current	IR	VR = 5V		U.S.L*)x2.0
Luminous intensity	IV	IF=20mA	L.S.L*)x0.7	

U.S.L: Upper standard level

L.S.L: Lower standard level

The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.





### 1.Storage time

LED can be stored for a year under the condition: the temperature of  $5^{\circ}\text{C}$ -28°C and humility of RH60%, These production must be re-inspected and tested before use if their storage time exceed a year.

#### 2.ESD countermeasure

Static electricity and high volt can damage LED, must put on static glove and static fillet, Soldering tool and the cover of device must connect the ground, soldering condition follows the related stating of production specification manual.

### 3.Soldering

When soldering leave a minimum of 2mm clearance from the base of the lens to the soldering point.

Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering conditions:

ng iron	Wave s	oldering
	Pre-heat	<b>120</b> ℃ Max
320°C Max	Pre-heat time	120 sec.Max
3 sec.Max	Solder wave	260℃ Max 5 sec.Max
		Pre-heat  320°C Max Pre-heat time  3 sec.Max Solder wave

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED.

#### 4. Drive Method

An LED is a current-operated device, In order to ensure intenity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.



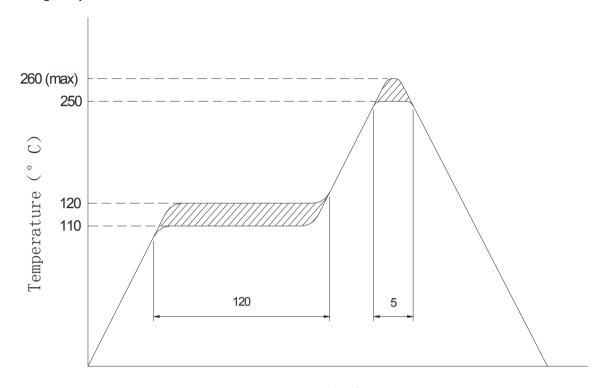
(A)Recommended circuit

(B)The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

REV NO: A/1 Page :5 of 6







Time (sec)

### **NOTES**

- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

REV NO: A/1 Page:6 of 6